

FORM PTO 1448 (modified)			ATTY DOCKET NO. <b>03650.002191</b>	APPLICATION NO. <b>10/866,787</b>			
U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE			APPLICANT <b>YOSHIMASA OKAMURA</b>				
LIST OF REFERENCES CITED BY APPLICANT(S) (Use several sheets if necessary)			FILING DATE <b>9/19/03</b> <i>Herewith</i>	GROUP <b>3700</b>			
U.S. PATENT DOCUMENTS							
*EXAMINER		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
<i>Cja</i>		<b>4,971,632</b>	<b>11/20/1990</b>	<b>Rowe</b>	<b>136</b>	<b>212</b>	
<i>Cja</i>		<b>4,983,225</b>	<b>01/08/1991</b>	<b>Rowe</b>	<b>136</b>	<b>201</b>	
<i>Cja</i>		<b>5,286,304</b>	<b>02/15/1994</b>	<b>Macris, et al.</b>	<b>136</b>	<b>201</b>	
<i>Cja</i>		<b>5,837,929</b>	<b>11/17/1998</b>	<b>Adelman</b>	<b>136</b>	<b>225</b>	
<i>Cja</i>		<b>5,921,087</b>	<b>07/13/1999</b>	<b>Bhatia, et al.</b>	<b>62</b>	<b>3.2</b>	
<i>Cja</i>		<b>6,127,619</b>	<b>10/03/2000</b>	<b>Xi, et al.</b>	<b>136</b>	<b>203</b>	
<i>Cja</i>		<b>6,207,887</b>	<b>03/27/2001</b>	<b>Bass, et al.</b>	<b>136</b>	<b>201</b>	
<i>Cja</i>		<b>6,214,738</b>	<b>04/10/2001</b>	<b>Aiba, et al.</b>	<b>438</b>	<b>707</b>	
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO/ OR ABSTRACT
<i>Cja</i>		<b>63-20880</b>	<b>01/28/1988</b>	<b>JAPAN</b>			<b>Abstract</b>
<i>Cja</i>		<b>11-298051</b>	<b>10/29/1999</b>	<b>JAPAN</b>			<b>Abstract</b>
<i>Cja</i>		<b>2001-282396</b>	<b>10/12/2001</b>	<b>JAPAN</b>			<b>Abstract</b>
OTHER DOCUMENT(S) (Including Author, Title, Date, Pertinent Pages, Etc.)							
<i>Cja</i>		<b>U.S. Patent Publication No. US 2001/0001961 A1</b>					
<i>Cja</i>		<b>U.S. Patent Publication No. US 2003/0041892 A1</b>					
<i>Cja</i>		<b>U.S. Patent Publication No. US 2003/0047204 A1</b>					
EXAMINER	<i>C.J. -Arbes</i>	DATE CONSIDERED <b>2/24/05</b>					

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FORM PTO 1449 (modified) U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE			ATTY DOCKET NO. <b>03650.002191</b>	APPLICATION NO. <b>10/666,787</b>			
LIST OF REFERENCES CITED BY APPLICANT(S) (Use several sheets if necessary)			APPLICANT <b>YOSHIMASA OKAMURA</b>				
			FILING DATE <b>7/19/03 Herewith</b>	GROUP <b>3700</b>			
U.S. PATENT DOCUMENTS							
*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
Ga		6,231,744	05/15/2001	Ying, et al.	205	324	
Cja		6,232,542	05/15/2001	Hiraishi, et al.	136	201	
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Cja		6,441,295	08/27/2002	Hiraishi, et al.	136	201	
Cja		6,441,296	08/27/2002	Hiraishi, et al.	136	201	
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		“Introduction to Thermoelectrics”, website, <a href="http://www.thermoelectrics.com/introduction.htm">http://www.thermoelectrics.com/introduction.htm</a> , site visited July 28, 2003.					
Cja		M.S. Dresselhaus, et al., “The Promise of Low Dimensional Systems for Thermoelectric Applications,” website, <a href="http://www.osti.gov/fcvt/darpa2002/mdresselhaus.pdf">http://www.osti.gov/fcvt/darpa2002/mdresselhaus.pdf</a> , site visited September 18, 2003, by applicant					
Cja		“THERMOELECTRICITY” website, <a href="http://www.nanotherm.org/public_main.htm">http://www.nanotherm.org/public_main.htm</a> , site visited July 28, 2003, by applicant					
Cja		“Stacy Group” Stacy Group Thermoelectrics Research, website, <a href="http://www.ccchem.berkeley.edu/~amsgrp/thermoelectrics.html">http://www.ccchem.berkeley.edu/~amsgrp/thermoelectrics.html</a> , site visited August 29, 2003,					
EXAMINER	C.J. Arbes		DATE CONSIDERED 2/29/05		by applicant		

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OTHER DOCUMENT(S) (Including Author, Title, Date, Pertinent Pages, Etc.)							
<i>Cja</i>		<b>"Design of Advanced Materials"</b> Stacy Group Home, website, <a href="http://www.cchem.berkeley.edu/~amsgrp/index.html">http://www.cchem.berkeley.edu/~amsgrp/index.html</a> , site visited July 28, 2003, by applicant					
<i>Cja</i>		<b>"Eneco Technology"</b> r-layout2, website, <a href="http://www.eneco-usa.com/technology/content.htm">http://www.eneco-usa.com/technology/content.htm</a> , site visited July 28, 2003, by applicant					
<i>Cja</i>		<b>Marlow Industries Inc."</b> thermoelectric manufacturer Marlow Industries inc., website, <a href="http://www.marlow.com/">http://www.marlow.com/</a> , site visited July 28, 2003, by applicant					
<i>Cja</i>		<b>Hi-Z Technology"</b> Hi-Z TECHNOLOGY, INC., website, <a href="http://www.hi-z.com/">http://www.hi-z.com/</a> , site visited July 28, 2003, by applicant					
<i>Cja</i>		<b>"TELLUREX Z-Max thermoelectric modules for power generation..."</b> Tellurex Corporation, website, <a href="http://www.tellurex.com/">http://www.tellurex.com/</a> , site visited July 28, 2003, by applicant					
<i>Cja</i>		<b>"A Quantum Leap in Power Generation"</b> Power Chips plc, website, <a href="http://www.powerchips.gi/">http://www.powerchips.gi/</a> , site visited July 28, 2003, by applicant					
<i>ya</i>		<b>"The Science Behind Power Chips™, A Basic Introduction"</b> Power Chips plc, website, <a href="http://www.powerchips.gi/technology/overview.shtml">http://www.powerchips.gi/technology/overview.shtml</a> , site visited July 28, 2003, <del>not considered</del> by applicant					
<i>Cja</i>		<b>M.S. Dresselhaus, et al., "INVESTIGATION OF LOW-DIMENSIONAL THERMOELECTRICS", Symposium Proceeding, Technomic Publishing Co., pp. 1-13,</b> <del>not considered</del> by applicant					
EXAMINER	<i>C.J. Arbes</i>		DATE CONSIDERED <i>1/24/05</i>				

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